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# MOS FIELD EFFECT TRANSISTOR 2SK2410

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK2410 is N-Channel MOS Field Effect Transistor designed for high speed switching applications.

#### **FEATURES**

• Low On-Resistance

 $R_{DS(on)1} = 40 \text{ m}\Omega \text{ MAX.}$  (@ VGS = 10 V, ID = 15 A)  $R_{DS(on)2} = 60 \text{ m}\Omega \text{ MAX.}$  (@ VGS = 4 V, ID = 15 A)

- Low Ciss Ciss = 1500 pF TYP.
- High Avalanche Capability Ratings
- · Built-in G-S Gate Protection Diodes

#### **QUALITY GRADE**

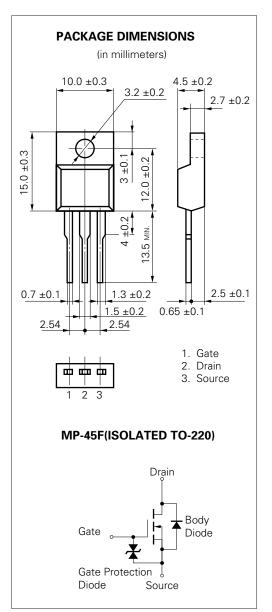
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID(DC)	±30	Α
Drain Current (pulse)*	D(pulse)	±120	Α
Total Power Dissipation (Tc = 25 °C)	P <sub>T1</sub>	35	W
Total Power Dissipation (T <sub>A</sub> = 25 °C)	P <sub>T2</sub>	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	$T_{\text{stg}}$	-55 to +150	°C
Single Avalanche Current**	las	30	Α
Single Avalanche Energy**	Eas	90	mJ

- \* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %
- \*\* Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0



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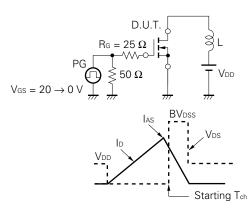


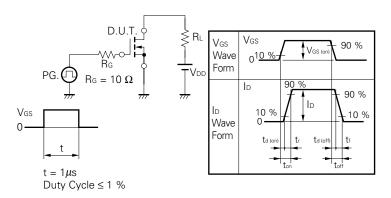
# **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS(on)1		31	40	mΩ	Vgs = 10 V, ID = 15 A
Drain to Source On-Resistance	RDS(on)2		40	60	mΩ	Vgs = 4 V, ID = 15 A
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	1.0	1.5	2.0	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	l yfs l	15	27		S	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 15 A
Drain Leakage Current	IDSS			10	μΑ	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0
Gate to Source Leakage Current	Igss			±10	μΑ	$V_{GS} = \pm 20 \text{ V, } V_{DS} = 0$
Input Capacitance	Ciss		1500		pF	V <sub>DS</sub> = 10 V
Output Capacitance	Coss		720		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		190		pF	f = 1 MHz
Turn-On Delay Time	td(on)		22		ns	ID = 15 A
Rise Time	tr		260		ns	VGS(on) = 10 V
Turn-Off Delay Time	td(off)		130		ns	V <sub>DD</sub> = 30 V
Fall Time	tf		150		ns	$R_G = 10 \Omega$
Total Gate Charge	Q <sub>G</sub>		50		nC	ID = 30 A
Gate to Source Charge	Qgs		5.0		nC	V <sub>DD</sub> = 48 V
Gate to Drain Charge	Q <sub>GD</sub>		15		nC	V <sub>GS</sub> = 10 V
Body Diode Forward Voltage	V <sub>F(S-D)</sub>		1.1		V	IF = 30 A, VGS = 0
Reverse Recovery Time	trr		110		ns	IF = 30 A, VGS = 0
Reverse Recovery Charge	Qrr		320		nC	di/dt = 100 A/μs

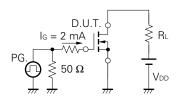
# **Test Circuit 1 Avalanche Capability**

# **Test Circuit 2 Switching Time**





# **Test Circuit 3 Gate Charge**

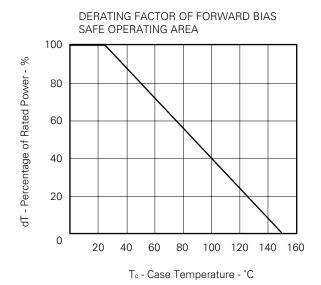


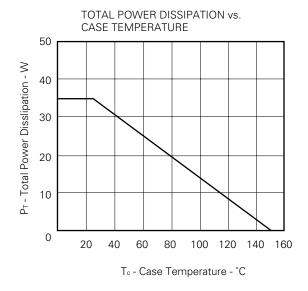
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

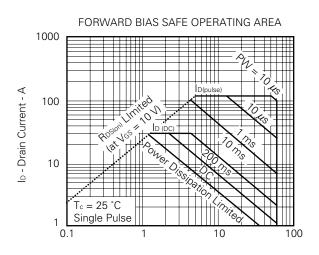
2

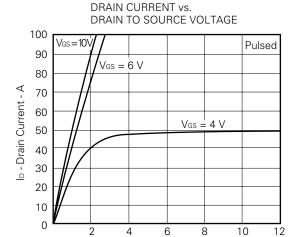


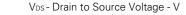
# TYPICAL CHARACTERISTICS (TA = 25 °C)



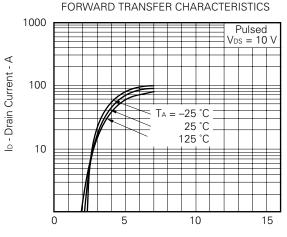








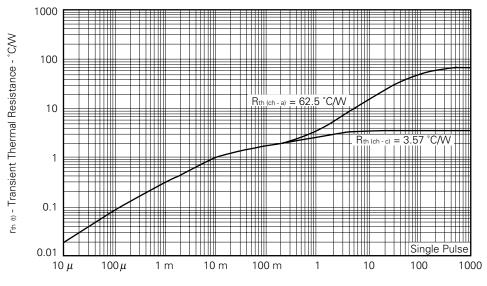
V<sub>DS</sub> - Drain to Source Voltage - V



V<sub>GS</sub> - Drain to Source Voltage - V

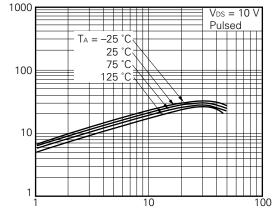


#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



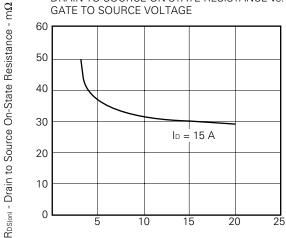
PW - Pulse Width - s





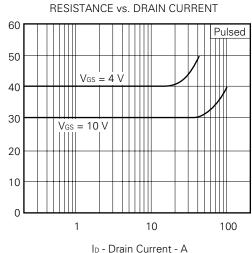
ID - Drain Current - A

#### DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE 60

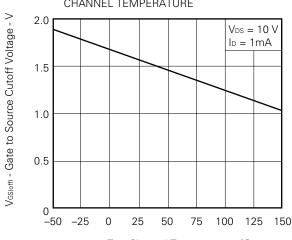


V<sub>GS</sub> - Gate to Source Voltage - V

# DRAIN TO SOURCE ON-STATE



GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

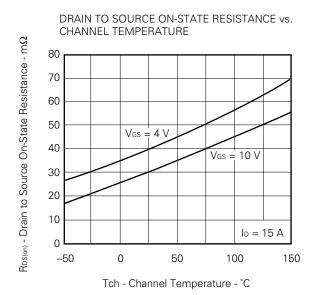


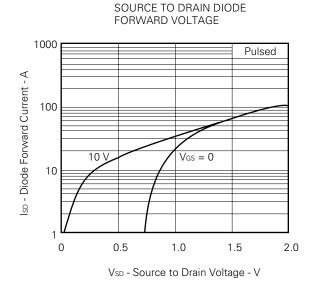
Tch - Channel Temperature - °C

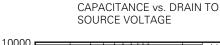
 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$  - Drain to Source On-State Resistance - m $\Omega$ 

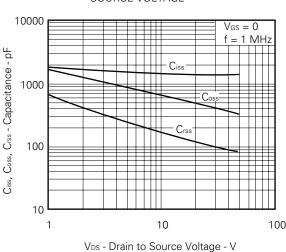
lyfsl - Forward Transfer Admittance - S



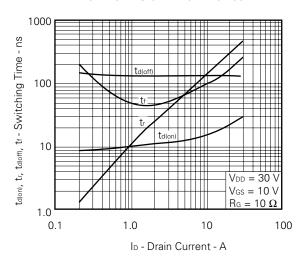




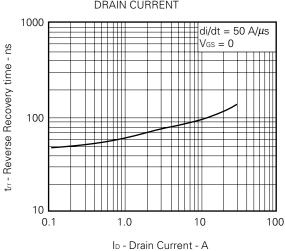




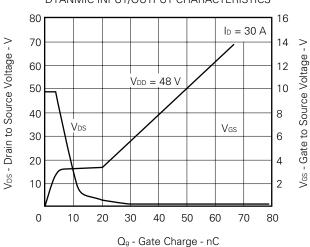
SWITCHING CHARACTERISTICS



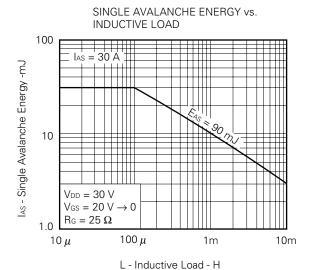
REVERSE RECOVERY TIME vs. **DRAIN CURRENT** 

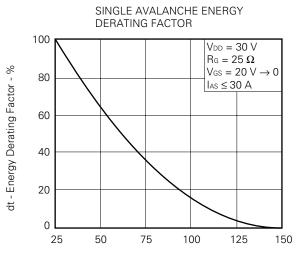


DYANMIC INPUT/OUTPUT CHARACTERISTICS









Starting  $T_{\text{ch}}$  - Starting Channel Temperature -  $^{\circ}\text{C}$ 



# **REFERENCE**

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

7

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